

2-Port USB 2.0 Hi-Speed Hub Controller

PRODUCT FEATURES

Data Brief

General Description

The SMSC USB2412 hub is a low-power, single transaction translator (STT) hub controller IC with two downstream ports for embedded USB applications. The SMSC hub controller supports low-speed, full-speed, and hi-speed (if operating as a hi-speed hub) downstream devices on all of the enabled downstream ports.

Features

- Fully integrated USB termination and pull-up/pull-down resistors
- Supports a single external 3.3 V supply source; internal regulators provide 1.2 V internal core voltage
- On-chip 24 MHz crystal and ceramic resonator driver or external 24 MHz clock input
- ESD protection up to 4 kilovolts on all USB pins
- Supports self-powered operation
- Contains a built-in default configuration; no external configuration options or components are required
- Downstream ports as optional non-removable ports
- Supports compound devices on a port-by-port basis
- 28-pin QFN (5 x 5 mm) lead-free RoHS compliant package
- Supports the commercial temperature range: 0°C to +70°C

Highlights

- High performance, low-power, small footprint hub controller IC with two downstream ports
- Fully compliant with the USB 2.0 specification
- 28QFN low pin count package
- Optimized for minimal bill-of-materials and low cost designs

Applications

- Automobile/home audio systems
- Cable/DSL modems
- Embedded systems
- Gaming consoles
- HDD enclosures
- IP telephony
- KVM switches
- LCD monitors and TVs
- Multi-function USB peripherals
- Mobile PC docking
- PC motherboards
- PC media drive bay
- Portable hub boxes
- Point-of-Sale (POS) systems
- Printers and scanners
- Server front panels
- Set-top boxes, DVD players, DVR/PVR
- Thin client terminals

Order Number(s):

ORDER NUMBERS	PACKAGE TYPE	PACKAGE SIZE	REEL SIZE
USB2412-DZK	28-Pin QFN Lead-Free, RoHS Compliant Package (includes tape and reel option)	5 x 5 x 0.5 mm	-
USB2412-DZK-TR			

This product meets the halogen maximum concentration values per IEC61249-2-21
For RoHS compliance and environmental information, please visit www.smsc.com/rohs



80 ARKAY DRIVE, HAUPPAUGE, NY 11788 (631) 435-6000 or 1 (800) 443-SEMI

Copyright © 2011 SMSC or its subsidiaries. All rights reserved.

Circuit diagrams and other information relating to SMSC products are included as a means of illustrating typical applications. Consequently, complete information sufficient for construction purposes is not necessarily given. Although the information has been checked and is believed to be accurate, no responsibility is assumed for inaccuracies. SMSC reserves the right to make changes to specifications and product descriptions at any time without notice. Contact your local SMSC sales office to obtain the latest specifications before placing your product order. The provision of this information does not convey to the purchaser of the described semiconductor devices any licenses under any patent rights or other intellectual property rights of SMSC or others. All sales are expressly conditional on your agreement to the terms and conditions of the most recently dated version of SMSC's standard Terms of Sale Agreement dated before the date of your order (the "Terms of Sale Agreement"). The product may contain design defects or errors known as anomalies which may cause the product's functions to deviate from published specifications. Anomaly sheets are available upon request. SMSC products are not designed, intended, authorized or warranted for use in any life support or other application where product failure could cause or contribute to personal injury or severe property damage. Any and all such uses without prior written approval of an Officer of SMSC and further testing and/or modification will be fully at the risk of the customer. Copies of this document or other SMSC literature, as well as the Terms of Sale Agreement, may be obtained by visiting SMSC's website at <http://www.smsc.com>. SMSC is a registered trademark of Standard Microsystems Corporation ("SMSC"). Product names and company names are the trademarks of their respective holders.

SMSC DISCLAIMS AND EXCLUDES ANY AND ALL WARRANTIES, INCLUDING WITHOUT LIMITATION ANY AND ALL IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, TITLE, AND AGAINST INFRINGEMENT AND THE LIKE, AND ANY AND ALL WARRANTIES ARISING FROM ANY COURSE OF DEALING OR USAGE OF TRADE. IN NO EVENT SHALL SMSC BE LIABLE FOR ANY DIRECT, INCIDENTAL, INDIRECT, SPECIAL, PUNITIVE, OR CONSEQUENTIAL DAMAGES; OR FOR LOST DATA, PROFITS, SAVINGS OR REVENUES OF ANY KIND; REGARDLESS OF THE FORM OF ACTION, WHETHER BASED ON CONTRACT; TORT; NEGLIGENCE OF SMSC OR OTHERS; STRICT LIABILITY; BREACH OF WARRANTY; OR OTHERWISE; WHETHER OR NOT ANY REMEDY OF BUYER IS HELD TO HAVE FAILED OF ITS ESSENTIAL PURPOSE, AND WHETHER OR NOT SMSC HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Block Diagram

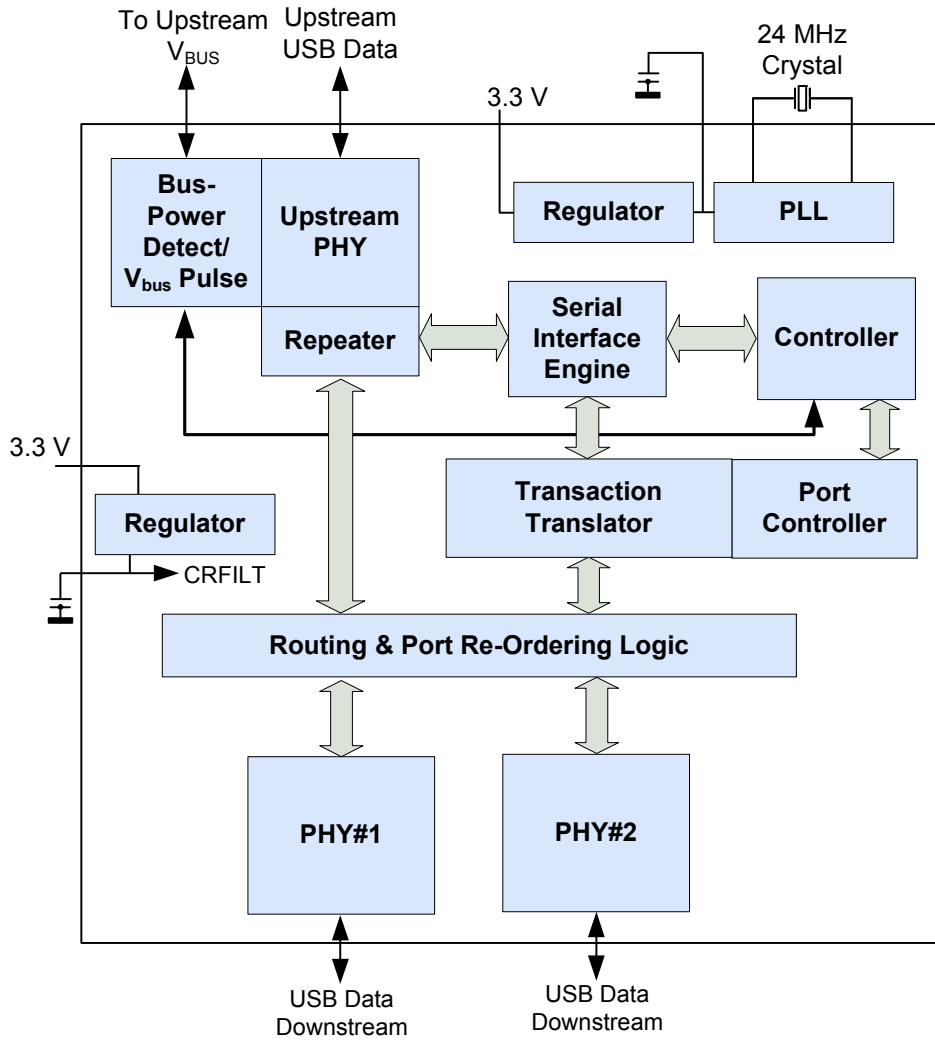


Figure 1 USB2412 Block Diagram

Package Outline

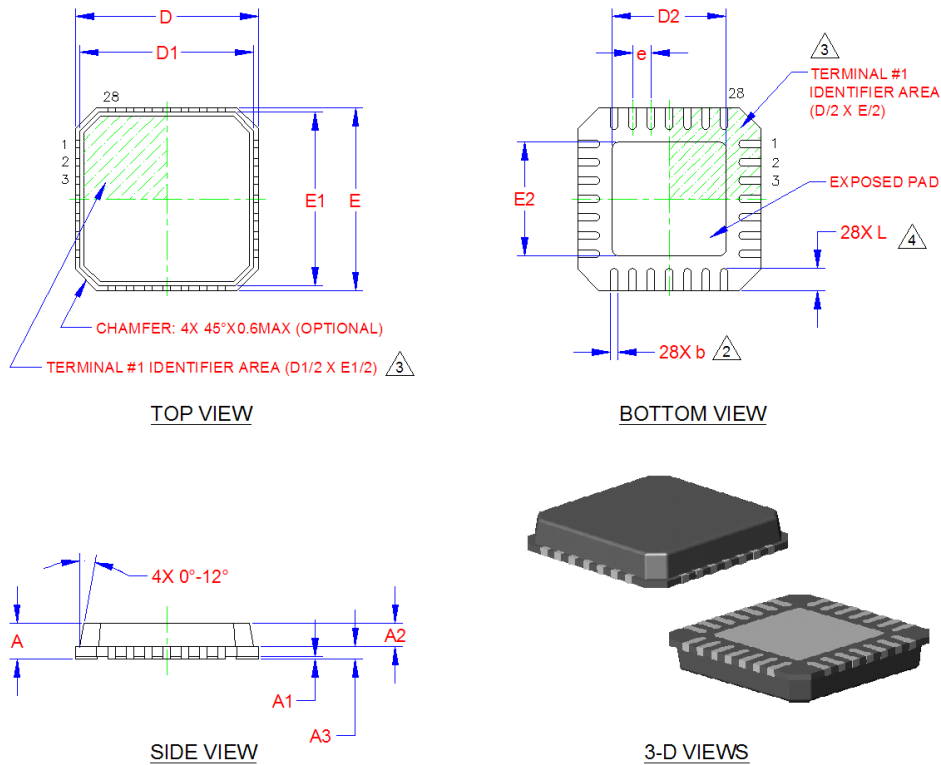


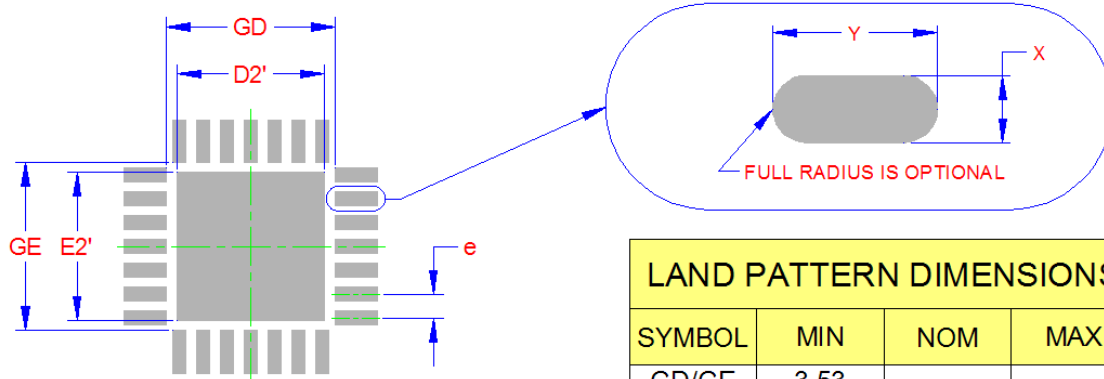
Figure 2 USB2412 28-Pin QFN Package Outline (5x5 mm Body, 0.5 Pitch, 3.1 ePad)

Table 1 Package Parameters

	MIN	NOMINAL	MAX	NOTE	REMARKS
A	0.80	0.85	1.00	-	Overall Package Height
A1	0	0.02	0.05	-	Standoff
A2	0.60	-	0.80	-	Mold Cap Thickness
D/E	4.90	5.00	5.10	-	X/Y Overall Body Size
D1/E1	4.55	4.75	4.95	-	X/Y Mold Cap Size
D2/E2	3.00	3.10	3.20	-	X/Y Exposed Pad Size
L	0.30	0.40	0.50	-	Terminal Length
b	0.18	0.25	0.30	2	Terminal Width
K	0.45	0.55	-	-	Terminal to ePad Clearance
e	0.50 BSC			-	Terminal Pitch

Notes:

- All dimensions are in millimeters.
- Position tolerance of each terminal and exposed pad is ± 0.05 mm at maximum material condition. Instances of dimension "b" apply to plated terminals and is measured between 0.15 and 0.33 mm from the terminal tip.
- Details of terminal #1 identifier are optional. However, they must be located within the area indicated.
- Coplanarity zone applies to exposed pad and terminals.



THE USER MAY MODIFY THE PCB LAND PATTERN DIMENSIONS BASED ON THEIR EXPERIENCE AND/OR PROCESS CAPABILITY

LAND PATTERN DIMENSIONS			
SYMBOL	MIN	NOM	MAX
GD/GE	3.53	-	-
D2'/E2'	-	3.10	-
X	-	-	0.28
Y	-	-	0.89
e	0.50		

RECOMMENDED PCB LAND PATTERN

Figure 3 Recommended Printed Circuit Board (PCB) Land Pattern